

# HOSTAFORM® HL100

## HOSTAFORM®

- High viscosity friction & wear polyacetal homopolymer
- non-silicon type special polymer modified wear-friction resistance grade for injection molding
- Designed for applications requiring reduced wear, low friction and low noise.

### Product information

Resin Identification	POM	ISO 1043
Part Marking Code	>POM<	ISO 11469

### Rheological properties

Melt mass-flow rate	2.2 g/10min	ISO 1133
Melt mass-flow rate, Temperature	190 °C	
Melt mass-flow rate, Load	2.16 kg	
Moulding shrinkage, parallel	2.1 %	ISO 294-4, 2577
Moulding shrinkage, normal	0 %	ISO 294-4, 2577

### Typical mechanical properties

Tensile modulus	2700 MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	65 MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	20 %	ISO 527-1/-2
Nominal strain at break	43 %	ISO 527-1/-2
Flexural modulus	2580 MPa	ISO 178
Flexural strength	86 MPa	ISO 178
Charpy impact strength, 23°C	N kJ/m <sup>2</sup>	ISO 179/1eU
Charpy notched impact strength, 23°C	8.9 kJ/m <sup>2</sup>	ISO 179/1eA
Poisson's ratio	0.38 <sup>[C]</sup>	

[C]: Calculated

### Thermal properties

Melting temperature, 10°C/min	177 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	100 °C	ISO 75-1/-2

### Physical/Other properties

Density	1410 kg/m <sup>3</sup>	ISO 1183
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### Injection

Drying Recommended	no
Drying Temperature	100 °C
Drying Time, Dehumidified Dryer	3 - 4 h
Processing Moisture Content	≤0.2 %
Melt Temperature Optimum	205 °C
Min. melt temperature	190 °C
Max. melt temperature	220 °C
Screw tangential speed	≤0.3 m/s
Mold Temperature Optimum	70 °C
Min. mould temperature	60 °C
Max. mould temperature	80 °C
Hold pressure range	60 - 120 MPa

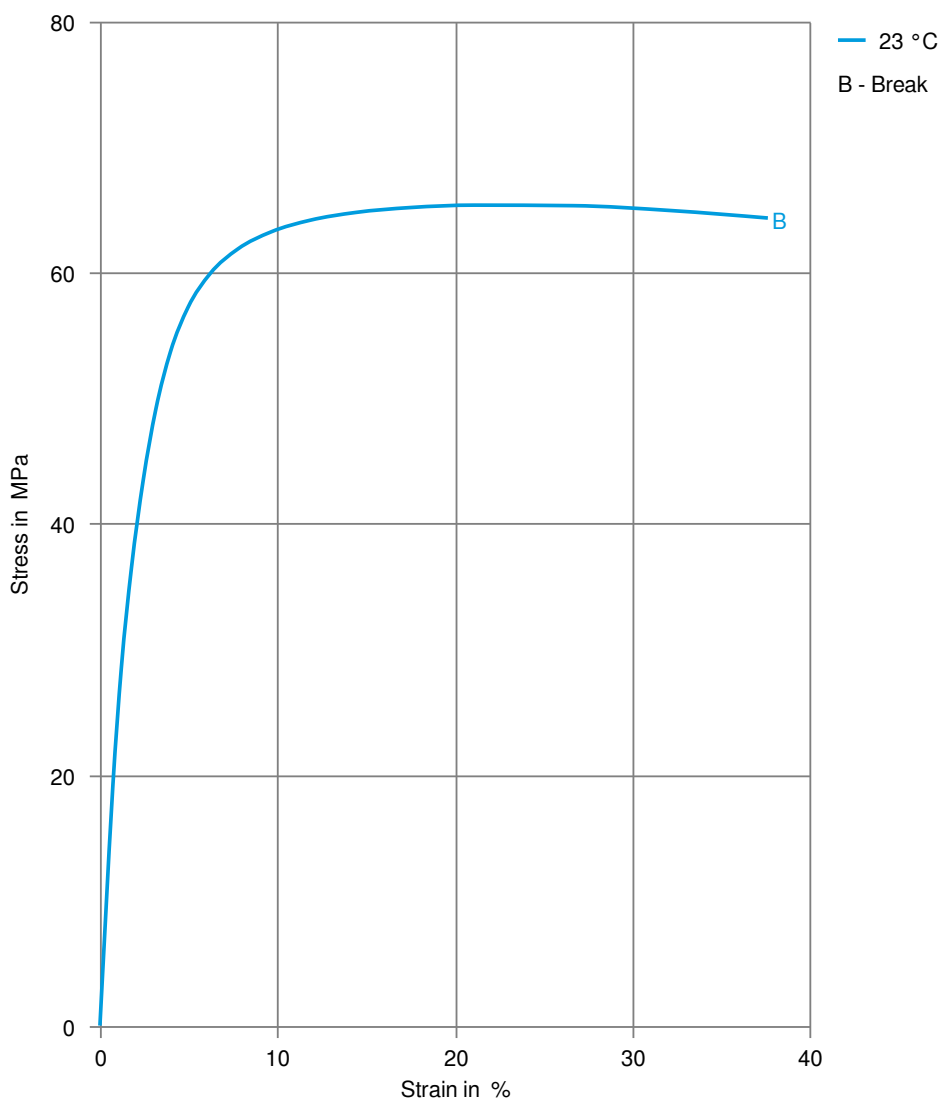
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## Characteristics

Processing	Injection Moulding
Delivery form	Pellets
Special characteristics	Low wear / Low friction

## Stress-strain



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## Secant modulus-strain

